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#### **TS5A23166**

SCDS196J-MAY 2005-REVISED SEPTEMBER 2019

# TS5A23166 0.9- $\Omega$ Dual-SPST Analog Switch 5-V and 3.3-V 2-Channel Analog Switch

#### 1 Features

- Isolation in Powered-Down Mode,  $V_{+} = 0$
- Low ON-state resistance (0.9  $\Omega$ )
- Control inputs are 5.5-V Tolerant
- Low charge injection
- Excellent ON-state resistance matching
- Low total harmonic distortion (THD)
- 1.65-V to 5.5-V Single-supply operation
- Latch-up performance exceeds 100 mA per JESD 78, class II
- ESD Performance tested per JESD 22
  - 2000-V Human-body model (A114-B, Class II)
  - 1000-V Charged-device model (C101)

# 2 Applications

- Cell phones •
- Portable instrumentation
- Audio and video signal routing
- Low-voltage data-acquisition systems
- **Communication circuits**
- Modems
- Hard Drives
- **Computer Peripherals**
- Wireless Terminals and Peripherals

# 3 Description

The TS5A23166 device is a dual single-pole singlethrow (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. The TS5A23166 device offers a low ON-state resistance and an excellent channel-to-channel ON-state resistance matching. The TS5A23166 device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

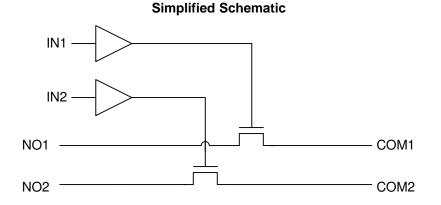
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### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |  |  |
|-------------|-----------|-------------------|--|--|
| T05400466   | VSSOP (8) | 2.30 mm × 2.00 mm |  |  |
| TS5A23166   | DSBGA (8) | 1.91 mm × 0.91 mm |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.



# **Table of Contents**

| 1 | Feat  | ures 1                                     |
|---|-------|--|
| 2 | App   | lications1                                 |
| 3 | Desc  | cription1                                  |
| 4 | Revi  | sion History 2                             |
| 5 | Pin ( | Configuration and Functions 3              |
| 6 | Spec  | cifications 3                              |
|   | 6.1   | Absolute Maximum Ratings 3                 |
|   | 6.2   | ESD Ratings 4                              |
|   | 6.3   | Recommended Operating Conditions 4         |
|   | 6.4   | Thermal Information 4                      |
|   | 6.5   | Electrical Characteristics: 5-V Supply 4   |
|   | 6.6   | Electrical Characteristics: 3.3-V Supply 6 |
|   | 6.7   | Electrical Characteristics: 2.5-V Supply7  |
|   | 6.8   | Electrical Characteristics: 1.8-V Supply   |
|   | 6.9   | Switching Characteristics: 5-V Supply 10   |
|   | 6.10  | Switching Characteristics: 3.3-V Supply 10 |
|   | 6.11  | Switching Characteristics: 2.5-V Supply 10 |
|   | 6.12  | Switching Characteristics: 1.8-V Supply 11 |
|   | 6.13  | Typical Characteristics 12                 |
| 7 | Para  | meter Measurement Information 14           |
|   |       |  |

| 8  | Deta | iled Description                  | 18 |
|----|------|-----------------------------------|----|
|    | 8.1  | Overview                          | 18 |
|    | 8.2  | Functional Block Diagram          | 18 |
|    | 8.3  | Feature Description               | 18 |
|    | 8.4  | Device Functional Modes           | 18 |
| 9  | Арр  | lication and Implementation       | 19 |
|    | 9.1  | Application Information           |    |
|    | 9.2  | Typical Application               |    |
| 10 | Pow  | ver Supply Recommendations        | 20 |
| 11 | Lay  | out                               | 20 |
|    | 11.1 | Layout Guidelines                 | 20 |
|    | 11.2 | Layout Example                    | 20 |
| 12 | Dev  | ice and Documentation Support     | 21 |
|    | 12.1 | Device Support                    | 21 |
|    | 12.2 |                                   |    |
|    | 12.3 | Community Resources               |    |
|    | 12.4 | Trademarks                        | 22 |
|    | 12.5 | Electrostatic Discharge Caution   | 22 |
|    | 12.6 | -                                 |    |
| 13 | Mec  | hanical, Packaging, and Orderable |    |
|    |      | rmation                           | 22 |
|    |      |                                   |    |

### **4** Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Revision I (March 2018) to Revision J

| •  | Changed the Thermal Information table           | 4    | 4 |
|----|---|------|---|
|    |   |      |   |
| CI | hanges from Revision H (May 2015) to Revision I | Page | e |

### Changes from Revision H (May 2015) to Revision I

#### Changes from Revision G (February 2013) to Revision H

| • | Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional<br>Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device |
|---|---|
|   | and Documentation Support section, and Mechanical, Packaging, and Orderable Information section   |
| ٠ | Updated document to new TI data sheet format - no specification changes 1   |
| • | Removed Ordering Information table 1  |

#### Changes from Revision F (September 2012) to Revision G



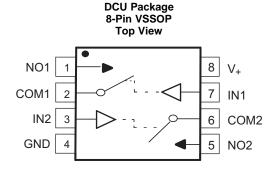
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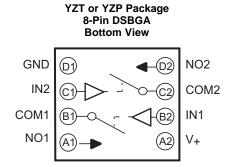
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# 5 Pin Configuration and Functions





#### **Pin Functions**

| PIN  |           |           | TYPE | DESCRIPTION                                     |  |  |
|------|-----------|-----------|------|---|--|--|
| NAME | TSSOP NO. | DSBGA NO. | ITPE | DESCRIPTION                                     |  |  |
| COM1 | 2         | B1        | I/O  | Common port for switch 1                        |  |  |
| COM2 | 6         | C2        | I/O  | Common port for switch 2                        |  |  |
| GND  | 4         | D1        | GND  | Ground  |  |  |
| IN1  | 7         | B2        | I    | Active-high control pin connecting NO1 to COM1. |  |  |
| IN2  | 3         | C1        | I    | Active-high control pin connecting NO2 to COM2. |  |  |
| NO1  | 1         | A1        | I/O  | Normally open switch path 1                     |  |  |
| NO2  | 5         | D2        | I/O  | Normally open switch path 2                     |  |  |
| V+   | 8         | A2        | PWR  | ower supply pin                                 |  |  |

# 6 Specifications

## 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

|                                     |   |                                   | MIN  | MAX                  | UNIT |
|-------------------------------------|---|-----------------------------------|------|----------------------|------|
| V <sub>+</sub>                      | Supply voltage <sup>(3)</sup>               |                                   | -0.5 | 6.5                  | V    |
| V <sub>NO</sub><br>V <sub>COM</sub> | Analog voltage <sup>(3)(4)(5)</sup>         |                                   | -0.5 | V <sub>+</sub> + 0.5 | V    |
| Ι <sub>Κ</sub>                      | Analog port diode current                   | $V_{NO}, V_{COM} < 0$             | -50  |                      | mA   |
| I <sub>NO</sub>                     | ON-state switch current                     | $V_{NO,} V_{COM} = 0$ to $V_{+}$  | -200 | 200                  | mA   |
| ICOM                                | ON-state peak switch current <sup>(6)</sup> | $V_{NO}$ , $V_{COM} = 0$ to $V_+$ | -400 | 400                  | mA   |
| VI                                  | Digital input voltage <sup>(3)(4)</sup>     |                                   | -0.5 | 6.5                  | V    |
| I <sub>IK</sub>                     | Digital input clamp current                 | V <sub>1</sub> < 0                | -50  |                      | mA   |
| l+                                  | Continuous current through V <sub>+</sub>   |                                   |      | 100                  | mA   |
| I <sub>GND</sub>                    | Continuous current through GND              |                                   | -100 | 100                  | mA   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

(3) All voltages are with respect to ground, unless otherwise specified.

(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(5) This value is limited to 5.5 V maximum.

(6) Pulse at 1-ms duration < 10% duty cycle.

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## 6.2 ESD Ratings

|                    |                         |   | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
| V <sub>(ESD)</sub> |                         | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>                   | +2000 |      |
|                    | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 $^{\left(2\right)}$ | +1000 | V    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

# 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                  |                                | MIN  | MAX            | UNIT |
|------------------|--------------------------------|------|----------------|------|
| V <sub>I/O</sub> | Input/output voltage           | 0    | V <sub>+</sub> | V    |
| V+               | Supply voltage                 | 1.65 | 5.5            | V    |
| VI               | Control Input Voltage          | 0    | 5.5            | V    |
| T <sub>A</sub>   | Operating free-air temperature | -40  | 85             | °C   |

# 6.4 Thermal Information

|                      |  |             | TS5A23166   |             |      |
|----------------------|--|-------------|-------------|-------------|------|
|                      | THERMAL METRIC <sup>(1)</sup>                | DCU (VSSOP) | YZP (DSBGA) | YZT (DSBGA) | UNIT |
|                      |  | 8 PINS      | 8 PINS      | 8 PINS      |      |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance       | 212.2       | 99.9        | 99.7        | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance    | 77.6        | 1.0         | 1.4         | °C/W |
| $R_{\theta JB}$      | Junction-to-board thermal resistance         | 91.7        | 27.8        | 27.8        | °C/W |
| ΨJT                  | Junction-to-top characterization parameter   | 7.1         | 0.4         | 0.5         | °C/W |
| φ <sub>JB</sub>      | Junction-to-board characterization parameter | 91.1        | 27.8        | 27.7        | °C/W |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report.

# 6.5 Electrical Characteristics: 5-V Supply

 $V_{+} = 4.5 \text{ V}$  to 5.5 V,  $T_{A} = -40^{\circ}\text{C}$  to 85°C (unless otherwise noted)<sup>(1)</sup>

|                                       | PARAMETER                 | TEST COND   | ITIONS                    | TA   | V.    | MIN  | TYP  | MAX               | UNIT |
|---------------------------------------|---------------------------|---|---------------------------|------|-------|------|------|-------------------|------|
| Analog Switc                          | :h                        |   |                           |      | -     |      |      | •                 |      |
| V <sub>COM</sub> ,<br>V <sub>NO</sub> | Analog signal             |   |                           |      |       | 0    |      | V+                | V    |
| r .                                   | Peak ON resistance        | $0 \le V_{NO} \le V_+,$   | Switch ON,                | 25°C | 4.5 V |      | 0.9  | 1.1               | Ω    |
| r <sub>peak</sub>                     | Teak ON Tesistance        | $I_{COM} = -100 \text{ mA},$  | see Figure 11             | Full | 4.5 V |      |      | 1.2               | 52   |
| _                                     | ON-state resistance       | V <sub>NO</sub> = 2.5 V,  | Switch ON,                | 25°C | 4.5 V |      | 0.75 | 0.9               | 0    |
| r <sub>on</sub>                       | ON-State resistance       | $I_{COM} = -100 \text{ mA},$  | see Figure 11             | Full | 4.5 V |      |      | 1                 | Ω    |
|                                       | ON-state resistance       | V <sub>NO</sub> = 2.5 V,  | Switch ON,                | 25°C |       |      | 0.04 | 0.1               | Ω    |
| $\Delta r_{on}$                       | match between<br>channels | $I_{COM} = -100 \text{ mA},$  | see Figure 11             | Full | 4.5 V |      |      | 0.1               |      |
|                                       | ON-state resistance       | $0 \le V_{NO} \le V_+,$<br>$I_{COM} = -100 \text{ mA},$                                   | Switch ON, see Figure 11  | 25°C | 4.5 V |      | 0.2  |                   | Ω    |
| r <sub>on(flat)</sub>                 | flatness                  | $V_{NO} = 1 \text{ V}, 1.5 \text{ V}, 2.5 \text{ V},$<br>$I_{COM} = -100 \text{ mA},$     | Switch ON, see Figure 11  | 25°C |       |      | 0.15 | 0.25              |      |
|                                       |                           |   |                           | Full |       |      |      | 0.25              |      |
|                                       |                           | V <sub>NO</sub> = 1 V,  |                           | 25°C |       | 0 V  | 4    | 20 <sup>(2)</sup> |      |
| I <sub>NO(OFF)</sub>                  | NO<br>OFF leakage current | $V_{COM} = 4.5 \text{ V},$<br>or<br>$V_{NO} = 4.5 \text{ V},$<br>$V_{COM} = 1 \text{ V},$ | Switch OFF, see Figure 12 | Full | 5.5 V | -150 |      | 150               | nA   |
|                                       |                           | V <sub>NO</sub> = 0 to 5.5 V,   | Switch OFF,               | 25°C | - 0 V | -10  | 0.2  | 10 <sup>(2)</sup> | μA   |
| NO(PWROFF)                            |                           |   | see Figure 12             | Full |       | -50  |      | 50                |      |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

- (2) Not tested in production.
- 4 Submit Documentation Feedback



## **Electrical Characteristics: 5-V Supply (continued)**

 $V_{\star}$  = 4.5 V to 5.5 V,  $T_{A}$  = –40°C to 85°C (unless otherwise noted)^{(1)}

|                       | PARAMETER                        | TEST CON   | NDITIONS                                 | TA   | V.    | MIN  | TYP    | MAX               | UNIT |
|-----------------------|----------------------------------|--|--|------|-------|------|--------|-------------------|------|
|                       |                                  | $V_{COM} = 1 V,$   |  | 25°C |       | 0 V  | 4      | 20 <sup>(2)</sup> |      |
| I <sub>COM(OFF)</sub> | COM<br>OFF leakage current       | $V_{NO}^{COM} = 4.5 \text{ V},$<br>or<br>$V_{COM} = 4.5 \text{ V},$<br>$V_{NO} = 1 \text{ V},$   | Switch OFF, see Figure 12                | Full | 5.5 V | -150 |        | 150               | nA   |
| 1                     |                                  | V <sub>COM</sub> = 0 to 5.5 V,   | Switch OFF,                              | 25°C | - 0 V | -10  | 0.2    | 10 <sup>(2)</sup> |      |
| ICOM(PWROFF)          |                                  | $V_{NO} = 5.5 V \text{ to } 0,$  | see Figure 12                            | Full | 0 V   | -50  |        | 50                | μA   |
|                       |                                  | $V_{NO} = 1 V,$  |  | 25°C |       | -5   | 0.4    | 5 <sup>(2)</sup>  |      |
| I <sub>NO(ON)</sub>   | NO<br>ON leakage current         | $V_{COM}^{OM}$ = Open,<br>or<br>$V_{NO}$ = 4.5 V,<br>$V_{COM}$ = Open,   | Switch ON, see Figure 13                 | Full | 5.5 V | -50  |        | 50                | nA   |
|                       |                                  | $V_{COM} = 1 V,$   |  | 25°C |       | -5   | 0.4    | 5 <sup>(2)</sup>  |      |
| I <sub>COM(ON)</sub>  | COM<br>ON leakage current        | $\label{eq:VNO} \begin{array}{l} V_{\text{NO}} = \text{Open}, \\ \text{or} \\ V_{\text{COM}} = 4.5 \text{ V}, \\ V_{\text{NO}} = \text{Open}, \end{array}$ | Switch ON, see Figure 13                 | Full | 5.5 V | -50  |        | 50                | nA   |
| Digital Control       | Inputs (IN1, IN2) <sup>(3)</sup> |  |  |      |       |      |        |                   |      |
| V <sub>IH</sub>       | Input logic high                 |  |  | Full |       | 2.4  |        | 5.5               | V    |
| V <sub>IL</sub>       | Input logic low                  |  |  | Full |       | 0    |        | 0.8               | V    |
| կլ, կլ                | Input leakage current            | V <sub>1</sub> = 5.5 V or 0  |  | 25°C | 5.5 V | -2   | 0.3    | 2                 | nA   |
| ıH, ıL                | input leakage current            | VI = 3.5 V 01 0  |  | Full | 5.5 V | -20  |        | 20                | ПА   |
| Dynamic               |                                  |  |  |      |       |      |        |                   |      |
| Q <sub>C</sub>        | Charge injection                 |  | C <sub>L</sub> = 1 nF,<br>see Figure 19  | 25°C | 5 V   |      | 6      |                   | рС   |
| C <sub>NO(OFF)</sub>  | NO<br>OFF capacitance            | $V_{NO} = V_{+}$ or GND,<br>Switch OFF,  | See Figure 14                            | 25°C | 5 V   |      | 19     |                   | pF   |
| C <sub>COM(OFF)</sub> | COM<br>OFF capacitance           | $V_{COM} = V_+ \text{ or GND},$<br>Switch OFF,   | See Figure 14                            | 25°C | 5 V   |      | 18     |                   | pF   |
| C <sub>NO(ON)</sub>   | NO<br>ON capacitance             | $V_{NO} = V_{+}$ or GND,<br>Switch ON,   | See Figure 14                            | 25°C | 5 V   |      | 35.5   |                   | pF   |
| C <sub>COM(ON)</sub>  | COM<br>ON capacitance            | $V_{COM} = V_{+}$ or GND,<br>Switch ON,  | See Figure 14                            | 25°C | 5 V   |      | 35.5   |                   | pF   |
| Cı                    | Digital input<br>capacitance     | $V_1 = V_+ \text{ or GND},$  | See Figure 14                            | 25°C | 5 V   |      | 2      |                   | pF   |
| BW                    | Bandwidth                        | $R_L = 50 \Omega$ ,<br>Switch ON,  | See Figure 16                            | 25°C | 5 V   |      | 150    |                   | MHz  |
| O <sub>ISO</sub>      | OFF isolation                    | $\begin{array}{l} R_L = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$  | Switch OFF, see Figure 17                | 25°C | 5 V   |      | -62    |                   | dB   |
| X <sub>TALK</sub>     | Crosstalk                        | $\begin{array}{l} R_L = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$  | Switch ON, see Figure 18                 | 25°C | 5 V   |      | -85    |                   | dB   |
| THD                   | Total harmonic distortion        | $R_L = 600 \Omega,$<br>$C_L = 50 pF,$  | f = 20 Hz to 20<br>kHz,<br>see Figure 20 | 25°C | 5 V   | (    | 0.005% |                   |      |
| Supply                |                                  |  |  | 1    | 1     | 1    |        |                   |      |
| l+                    | Positive supply                  | $V_1 = V_+$ or GND,  | Switch ON or                             | 25°C | 5.5 V |      | 0.01   | 0.1               | μA   |
|                       | current                          | $v_1 = v_+ \text{ or GND}, 		OFF$  | Full                                     |      |       |      | 1      | P                 |      |

(3) All unused digital inputs of the device must be held at V<sub>+</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

STRUMENTS

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# 6.6 Electrical Characteristics: 3.3-V Supply

 $V_{\star}$  = 3 V to 3.6 V,  $T_{A}$  = –40°C to 85°C (unless otherwise noted)  $^{(1)}$ 

|                                       |  |  | DITIONS                      | T <sub>A</sub> | V.      | MIN       | TYP  | MAX                    | UNIT       |
|---------------------------------------|--|--|------------------------------|----------------|---------|-----------|------|------------------------|------------|
| Analog Switch                         | ı  |  |                              |                |         |           |      |                        |            |
| V <sub>COM</sub> ,<br>V <sub>NO</sub> | Analog signal range                              |  |                              |                |         | 0         |      | V+                     | V          |
| r <sub>peak</sub>                     | Peak ON resistance                               | $0 \le V_{NO} \le V_+,$<br>$I_{COM} = -100 \text{ mA},$  | Switch ON, see Figure 11     | 25°C<br>Full   | - 3 V   |           | 1.3  | 1.6<br>1.8             | Ω          |
| r <sub>on</sub>                       | ON-state resistance                              | $V_{NO} = 2 V,$<br>$I_{COM} = -100 \text{ mA},$  | Switch ON, see Figure 11     | 25°C<br>Full   | 3 V     |           | 1.1  | 1.5<br>1.7             | Ω          |
| ∆r <sub>on</sub>                      | ON-state resistance<br>match between<br>channels | V <sub>NO</sub> = 2 V, 0.8 V,<br>I <sub>COM</sub> = -100 mA,   | Switch ON, see Figure 11     | 25°C<br>Full   | 3 V     |           | 0.04 | 0.1<br>0.1             | Ω          |
|                                       | ON-state resistance                              | $0 \le V_{NO} \le V_+,$<br>$I_{COM} = -100 \text{ mA}$   | Switch ON, see Figure 11     | 25°C           |         |           | 0.3  |                        |            |
| r <sub>on(flat)</sub>                 | flatness   | $V_{NO} = 2 V, 0.8 V,$<br>$I_{COM} = -100 mA,$   | Switch ON, see Figure 11     | 25°C<br>Full   | 3 V     |           | 0.15 | 0.25<br>0.25           | Ω          |
| I <sub>NO(OFF)</sub>                  | NO   | $V_{NO} = 1 V, V_{COM} = 3 V,$<br>or<br>$V_{NO} = 3 V, V_{COM} = 1 V,$                                   | Switch OFF, see Figure 12    | 25°C<br>Full   | 3.6 V   | 5<br>50   | 0.5  | 5 <sup>(2)</sup><br>50 | nA         |
| I <sub>NO(PWROFF)</sub>               | OFF leakage current                              | $V_{NO} = 0 \text{ to } 3.6 \text{ V},$<br>$V_{COM} = 3.6 \text{ V to } 0,$                              | Switch OFF, see Figure 12    | 25°C<br>Full   | 0 V     | -5<br>-25 | 0.1  | 5 <sup>(2)</sup><br>25 | μΑ         |
| I <sub>COM(OFF)</sub>                 | СОМ  | $V_{COM} = 1 \text{ V},  V_{NO} = 3 \text{ V},$<br>or<br>$V_{COM} = 3 \text{ V},  V_{NO} = 1 \text{ V},$ | Switch OFF, see Figure 12    | 25°C<br>Full   | 3.6 V   | 5<br>50   | 0.5  | 5 <sup>(2)</sup><br>50 | nA         |
| I <sub>COM(PWROFF)</sub>              | OFF leakage current                              | $V_{COM} = 0 \text{ to } 3.6 \text{ V},$<br>$V_{NO} = 3.6 \text{ V to } 0,$                              | Switch OFF,<br>see Figure 12 | 25°C<br>Full   | - 0 V   | 5<br>25   | 0.1  | 5 <sup>(2)</sup><br>25 | μA         |
|                                       | NO   | $V_{NO} = 1 V,$<br>$V_{COM} = Open,$   | Switch ON,                   | 25°C           |         | -2        | 0.3  | 2 <sup>(2)</sup>       |            |
| I <sub>NO(ON)</sub>                   | ON leakage current                               | or<br>$V_{NO} = 3 V,$<br>$V_{COM} = Open,$   | see Figure 13                | Full           | 3.6 V   | -20       |      | 20                     | nA         |
|                                       | СОМ  | V <sub>COM</sub> = 1 V,<br>V <sub>NO</sub> = Open,   | Switch ON,                   | 25°C           | 261/    | -2        | 0.3  | 2 <sup>(2)</sup>       | <b>n</b> ( |
| I <sub>COM(ON)</sub>                  | ON leakage current                               | Or   | see Figure 13                | Full           | 3.6 V   | -20       |      | 20                     | nA         |
| Digital Contro                        | l Inputs (IN1, IN2) <sup>(3)</sup>               |  |                              |                |         |           |      |                        |            |
| V <sub>IH</sub>                       | Input logic high                                 |  |                              | Full           |         | 2         |      | 5.5                    | V          |
| V <sub>IL</sub>                       | Input logic low                                  |  |                              | Full           |         | 0         |      | 0.8                    | V          |
|                                       |  |  |                              | 25°C           | - 3.6 V | -2        | 0.3  | 2                      | nA         |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

(2) Not tested in production.

 (3) All unused digital inputs of the device must be held at V<sub>+</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# Electrical Characteristics: 3.3-V Supply (continued)

|--|

|                       | PARAMETER                 | TEST CO   | ONDITIONS                             | T <sub>A</sub> | V.    | MIN TYP | MAX  | UNIT |
|-----------------------|---------------------------|---|---------------------------------------|----------------|-------|---------|------|------|
| Dynamic               |                           |   |                                       |                |       |         |      |      |
| Q <sub>C</sub>        | Charge injection          | $V_{GEN} = 0,$<br>$R_{GEN} = 0,$                                    | $C_L = 1 nF,$<br>see Figure 19        | 25°C           | 5 V   | 6       |      | рС   |
| C <sub>NO(OFF)</sub>  | NO<br>OFF capacitance     | $V_{NO} = V_{+}$ or GND,<br>Switch OFF,                             | See Figure 14                         | 25°C           | 3.3 V | 19.5    |      | pF   |
| C <sub>COM(OFF)</sub> | COM<br>OFF capacitance    | $V_{COM} = V_+ \text{ or GND},$<br>Switch OFF,                      | See Figure 14                         | 25°C           | 3.3 V | 18.5    |      | pF   |
| C <sub>NO(ON)</sub>   | NO<br>ON capacitance      | $V_{NO} = V_{+}$ or GND,<br>Switch ON,                              | See Figure 14                         | 25°C           | 3.3 V | 36      |      | pF   |
| C <sub>COM(ON)</sub>  | COM<br>ON capacitance     | $V_{COM} = V_{+}$ or GND,<br>Switch ON,                             | See Figure 14                         | 25°C           | 3.3 V | 36      |      | pF   |
| CI                    | Digital input capacitance | $V_I = V_+ \text{ or GND},$   | See Figure 14                         | 25°C           | 3.3 V | 2       |      | pF   |
| BW                    | Bandwidth                 | $R_L = 50 \Omega$ ,<br>Switch ON,                                   | See Figure 16                         | 25°C           | 3.3 V | 150     |      | MHz  |
| O <sub>ISO</sub>      | OFF isolation             | $\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$ | Switch OFF, see Figure 17             | 25°C           | 3.3 V | -62     |      | dB   |
| X <sub>TALK</sub>     | Crosstalk                 | $\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$ | Switch ON, see Figure 18              | 25°C           | 3.3 V | -85     |      | dB   |
| THD                   | Total harmonic distortion | $R_L = 600 \Omega,$<br>$C_L = 50 pF,$                               | f = 20 Hz to 20 kHz,<br>see Figure 20 | 25°C           | 3.3 V | 0.01%   |      |      |
| Supply                |                           |   |                                       |                |       |         |      |      |
| 1                     | Positive supply           | $V_1 = V_{\pm}$ or GND,   | Switch ON or OFF                      | 25°C           | 3.6 V | 0.001   | 0.05 |      |
| I <sub>+</sub>        | current                   | $v_{\parallel} = v_{+}$ or GND,                                     | Switch ON OF OFF                      | Full           | 5.0 V |         | 0.3  | μA   |

# 6.7 Electrical Characteristics: 2.5-V Supply

 $V_{\star}$  = 2.3 V to 2.7 V,  $T_{A}$  = –40°C to 85°C (unless otherwise noted)  $^{(1)}$ 

| PAR                                | RAMETER                                    | TEST CO  | ONDITIONS                   | TA   | ٧.    | MIN   | TYP              | MAX              | UNIT       |  |
|------------------------------------|--|--|-----------------------------|------|-------|-------|------------------|------------------|------------|--|
| Analog Switch                      | า  |  |                             |      |       |       |                  |                  |            |  |
| V <sub>COM</sub> , V <sub>NO</sub> | Analog signal range                        |  |                             |      |       | 0     |                  | V <sub>+</sub>   | V          |  |
|                                    | Peak ON                                    | $0 \le V_{NO} \le V_+,$  | Switch ON,                  | 25°C | 2.3 V |       | 1.8              | 2.4              | Ω          |  |
| r <sub>peak</sub>                  | resistance                                 | $I_{COM} = -8 \text{ mA},$   | see Figure 11               | Full | 2.3 V |       |                  | 2.6              | Ω          |  |
| -                                  | ON-state                                   | V <sub>NO</sub> = 1.8 V,   | Switch ON,                  | 25°C | 2.3 V |       | 1.2              | 2.1              | Ω          |  |
| r <sub>on</sub>                    | resistance                                 | $I_{COM} = -8 \text{ mA},$   | see Figure 11               | Full | 2.3 V |       |                  | 2.4              | 12         |  |
|                                    | ON-state                                   |  |                             | 25°C |       |       | 0.04             | 0.15             |            |  |
| $\Delta r_{on}$                    | resistance<br>match<br>between<br>channels | atch $V_{NO} = 1.8 V, 0.8 V,$<br>$I_{COM} = -8 mA,$  | Switch ON,<br>see Figure 11 | Full | 2.3 V | 2.3 V |                  | 0.15             | Ω          |  |
|                                    | ON-state                                   | $\begin{array}{l} 0 \leq V_{\rm NO} \ \leq V_{\star}, \\ I_{\rm COM} = -8 \ {\rm mA}, \end{array}$ | Switch ON, see Figure 11    | 25°C |       |       | 0.7              |                  | 0.6<br>0.6 |  |
| r <sub>on(flat)</sub>              | resistance<br>flatness                     |  | Switch ON,                  | 25°C | 2.3 V |       | 0.4              | 0.6              |            |  |
|                                    | lialiooo                                   |  | see Figure 11               | Full |       |       |                  | 0.6              |            |  |
|                                    |  | V <sub>NO</sub> = 0.5 V,   |                             | 25°C |       | -5    | 0.3              | 5 <sup>(2)</sup> |            |  |
| I <sub>NO(OFF)</sub>               |  | NO<br>OFF leakage $V_{NO} = 2.3 V$ , see Figure $V_{COV} = 0.5 V$                                  | Switch OFF, see Figure 12   | Full | 2.7 V | -50   |                  | 50               | nA         |  |
|                                    | current                                    | Switch OFF,  | 25°C                        | 0 V  | -2    | 0.05  | 2 <sup>(2)</sup> |                  |            |  |
| INO(PWROFF)                        |  | $V_{COM} = 2.7 V \text{ to } 0,$ see Figure 12   |                             | Full | UV    | -15   |                  | 15               | μA         |  |

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

(2) Not tested in production.

# Electrical Characteristics: 2.5-V Supply (continued)

| $V_{+} = 2.3 \text{ V}$ to 2.7 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted) <sup>(1)</sup> | $V_{.} = 2$ | .3 V to 2.7 | V. $T_{A} = -40^{\circ}C$ | to 85°C (unle | ess otherwise noted) <sup>(1)</sup> |
|---|-------------|-------------|---------------------------|---------------|-------------------------------------|
|---|-------------|-------------|---------------------------|---------------|-------------------------------------|

| PAR                               | RAMETER                         | TEST CC   | NDITIONS                                | TA           | V.    | MIN       | TYP   | MAX                    | UNIT |
|-----------------------------------|---------------------------------|---|---|--------------|-------|-----------|-------|------------------------|------|
|                                   |                                 | V <sub>NO</sub> = 2.3 V,  |   | 25°C         |       | -5        | 0.3   | 5 <sup>(2)</sup>       |      |
| I <sub>COM(OFF)</sub>             | COM<br>OFF leakage              | $\begin{split} V_{\rm COM} &= 0.5 \ {\rm V}, \\ {\rm or} \\ V_{\rm NO} &= 0.5 \ {\rm V}, \\ V_{\rm COM} &= 2.3 \ {\rm V}, \end{split}$                              | Switch OFF,<br>see Figure 12            | Full         | 2.7 V | -50       |       | 50                     | nA   |
| I <sub>COM(PWROFF)</sub>          |                                 | $V_{COM} = 0$ to 2.7 V,   | Switch OFF,                             | 25°C         | 0 V   | -2        | 0.05  | 2 <sup>(2)</sup>       | μA   |
|                                   |                                 | $V_{\rm NO} = 2.7  \rm V  to  0,$   | see Figure 12                           | Full         |       | -15       |       | 15                     | •    |
| I <sub>NO(ON)</sub>               | NO<br>ON leakage<br>current     | $\label{eq:VNO} \begin{array}{l} V_{NO} = 0.5 \ \text{V}, \\ V_{COM} = \text{Open}, \\ \text{or} \\ V_{NO} = 2.3 \ \text{V}, \\ V_{COM} = \text{Open}, \end{array}$ | Switch ON, see Figure 13                | 25°C<br>Full | 2.7 V | -2<br>-20 | 0.3   | 2 <sup>(2)</sup><br>20 | nA   |
| I <sub>COM(ON)</sub>              | COM<br>ON leakage<br>current    | $\begin{array}{l} V_{COM} = 0.5 \text{ V}, \\ V_{NO} = \text{Open}, \\ \text{or} \\ V_{COM} = 2.3 \text{ V}, \\ V_{NO} = \text{Open}, \end{array}$                  | Switch ON, see Figure 13                | 25°C<br>Full | 2.7 V | -2<br>-20 | 0.3   | 2 <sup>(2)</sup><br>20 | nA   |
| Digital Control                   | Inputs (IN1, IN2)               |   |   |              |       |           |       |                        |      |
| V <sub>IH</sub>                   | Input logic high                |   |   | Full         |       | 1.8       |       | 5.5                    | V    |
| V <sub>IL</sub>                   | Input logic low                 |   |   | Full         |       | 0         |       | 0.6                    | V    |
| I <sub>IH</sub> , I <sub>IL</sub> | Input leakage<br>current        | $V_{I} = 5.5 V \text{ or } 0$   |   | 25°C<br>Full | 2.7 V | -2<br>-20 | 0.3   | 2<br>20                | nA   |
| Dynamic                           |                                 |   |   |              |       |           |       |                        |      |
| Q <sub>C</sub>                    | Charge injection                | $V_{GEN} = 0,$<br>$R_{GEN} = 0,$  | C <sub>L</sub> = 1 nF,<br>see Figure 19 | 25°C         | 2.5 V |           | 4     |                        | рС   |
| $C_{\text{NO(OFF)}}$              | NO<br>OFF<br>capacitance        | $V_{NO} = V_{+} \text{ or GND},$<br>Switch OFF,   | See Figure 14                           | 25°C         | 2.5 V |           | 19.5  |                        | pF   |
| C <sub>COM(OFF)</sub>             | COM<br>OFF<br>capacitance       | $V_{COM} = V_+ \text{ or GND},$<br>Switch OFF,  | See Figure 14                           | 25°C         | 2.5 V |           | 18.5  |                        | pF   |
| C <sub>NO(ON)</sub>               | NO<br>ON<br>capacitance         | $V_{NO} = V_{+} \text{ or GND},$<br>Switch ON,  | See Figure 14                           | 25°C         | 2.5 V |           | 36.5  |                        | pF   |
| C <sub>COM(ON)</sub>              | COM<br>ON<br>capacitance        | $V_{COM} = V_{+}$ or GND,<br>Switch ON,   | See Figure 14                           | 25°C         | 2.5 V |           | 36.5  |                        | pF   |
| Cı                                | Digital input capacitance       | $V_I = V_+ \text{ or GND},$   | See Figure 14                           | 25°C         | 2.5 V |           | 2     |                        | pF   |
| BW                                | Bandwidth                       | $R_L = 50 \Omega$ ,<br>Switch ON,   | See Figure 16                           | 25°C         | 2.5 V |           | 150   |                        | MHz  |
| O <sub>ISO</sub>                  | OFF isolation                   | $\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$   | Switch OFF,<br>see Figure 17            | 25°C         | 2.5 V |           | -62   |                        | dB   |
| X <sub>TALK</sub>                 | Crosstalk                       | $ \begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array} $   | Switch ON,<br>see Figure 18             | 25°C         | 2.5 V |           | -85   |                        | dB   |
| THD                               | Total<br>harmonic<br>distortion | $ \begin{aligned} R_{L} &= 600 \ \Omega, \\ C_{L} &= 50 \ pF, \end{aligned} $   | f = 20 Hz to 20 kHz,<br>see Figure 20   | 25°C         | 2.5 V |           | 0.02% |                        |      |
| Supply                            |                                 |   |   |              |       |           |       |                        |      |
| l_                                | Positive supply                 | $V_1 = V_+$ or GND,   | Switch ON or OFF                        | 25°C         | 2.7 V |           | 0.001 | 0.02                   | μA   |
| ·+                                | current                         | $v_1 = v_+ \text{ or OND},$   |   | Full         | 2.1 V |           |       | 0.25                   | μΛ   |



TS5A23166 SCDS196J – MAY 2005–REVISED SEPTEMBER 2019

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## 6.8 Electrical Characteristics: 1.8-V Supply

 $V_{\star}$  = 1.65 V to 1.95 V,  $T_{A}$  = –40°C to 85°C (unless otherwise noted)  $^{(1)}$ 

| PAR                                | AMETER   | TEST CO  | ONDITIONS                               | TA                       | ٧.       | MIN  | TYP  | MAX              | UNIT |                  |  |
|------------------------------------|--|--|---|--------------------------|----------|------|------|------------------|------|------------------|--|
| Analog Switch                      |  |  |   |                          |          |      |      |                  |      |                  |  |
| V <sub>COM</sub> , V <sub>NO</sub> | Analog signal range                                    |  |   |                          |          | 0    |      | V+               | V    |                  |  |
| r <sub>peak</sub>                  | Peak ON<br>resistance                                  | $0 \le V_{NO} \le V_+,$<br>$I_{COM} = -2 \text{ mA},$  | Switch ON,<br>see Figure 11             | 25°C<br>Full             | 1.65 V   |      | 4.2  | 25<br>30         | Ω    |                  |  |
| r <sub>on</sub>                    | ON-state<br>resistance                                 | $V_{NO} = 0.6 \text{ V}, 1.5 \text{ V},$<br>$I_{COM} = -2 \text{ mA},$   | Switch ON, see Figure 11                | 25°C                     | 1.65 V   |      | 1.6  | 3.9              | Ω    |                  |  |
|                                    |  |  | See Figure TT                           | Full                     |          |      |      | 4                |      |                  |  |
| Δr <sub>on</sub>                   | ON-state<br>resistance<br>match<br>between<br>channels | $V_{NO} = 1.5 V,$<br>$I_{COM} = -2 mA,$  | Switch ON, see Figure 11                | 25°C<br>Full             | 1.65 V   |      | 0.04 | 0.2              | Ω    |                  |  |
|                                    | ON-state   | $0 \le V_{NO} \le V_+,$<br>$I_{COM} = -2 \text{ mA},$  | Switch ON, see Figure 11                | 25°C                     | 1.65 V   |      | 2.8  |                  | _    |                  |  |
| r <sub>on(flat)</sub>              | resistance<br>flatness                                 | V <sub>NO</sub> = 0.6 V, 1.5 V,  | Switch ON,                              | 25°C                     |          |      | 4.1  | 22               | Ω    |                  |  |
|                                    | hailooo  | $I_{COM} = -2 \text{ mA},$   | see Figure 11                           | Full                     |          |      |      | 27               |      |                  |  |
|                                    |  | V <sub>NO</sub> = 0.3 V,   |   | 25°C                     |          | -5   | 0.3  | 5 <sup>(2)</sup> |      |                  |  |
| I <sub>NO(OFF)</sub>               | NO<br>OFF leakage<br>current                           | $V_{COM} = 1.65 \text{ V},$<br>or<br>$V_{NO} = 1.65 \text{ V},$<br>$V_{COM} = 0.3 \text{ V},$  | Switch OFF, see Figure 12               | Full                     | 1.95 V   | -50  |      | 50               | nA   |                  |  |
|                                    |  | $V_{NO} = 0$ to 1.95 V,  | Switch OFF,                             | 25°C                     | <u>.</u> | -2   | 0.05 | 2 <sup>(2)</sup> |      |                  |  |
| NO(PWROFF)                         |  | $V_{COM} = 1.95 V \text{ to } 0,$  | see Figure 12                           | Full                     | 0 V      | -10  |      | 10               | μA   |                  |  |
|                                    |  | V <sub>NO</sub> = 1.65 V,  |   | 25°C                     |          | -5   | 0.3  | 5 <sup>(2)</sup> |      |                  |  |
| I <sub>COM(OFF)</sub>              | COM<br>OFF leakage<br>current                          | $\begin{split} V_{COM} &= 0.3 \text{ V},\\ \text{or}\\ V_{NO} &= 0.3 \text{ V},\\ V_{COM} &= 1.65 \text{ V}, \end{split}$              | Switch OFF, see Figure 12               | Full                     | 1.95 V   | -50  |      | 50               | nA   |                  |  |
|                                    | current  | V <sub>COM</sub> = 0 to 1.95 V, S  | Switch OFF,                             | 25°C                     |          | -2   | 0.05 | (2)2             |      |                  |  |
| I <sub>COM(PWROFF)</sub>           |  | $V_{\rm NO} = 0.001.95$ V,<br>$V_{\rm NO} = 1.95$ V to 0,  | see Figure 12                           | Full                     | 0 V      | -10  |      | 10               | μA   |                  |  |
|                                    |  |  |   | V <sub>NO</sub> = 0.3 V, |          | 25°C |      | -2               | 0.3  | 2 <sup>(2)</sup> |  |
| I <sub>NO(ON)</sub>                | NO<br>ON leakage<br>current                            | $V_{COM} = Open,$<br>or<br>$V_{NO} = 1.65 V,$<br>$V_{COM} = Open,$   | Switch ON, see Figure 13                | Full                     | 1.95 V   | -20  |      | 20               | nA   |                  |  |
|                                    |  | V <sub>NO</sub> = Open,  |   | 25°C                     |          | -2   | 0.3  | 2                |      |                  |  |
| I <sub>COM(ON)</sub>               | COM<br>ON leakage<br>current                           | $\label{eq:com} \begin{array}{l} V_{COM} = 0.3 \text{ V},\\ \text{or}\\ V_{NO} = \text{Open},\\ V_{COM} = 1.65 \text{ V}, \end{array}$ | Switch ON, see Figure 13                | Full                     | 1.95 V   | -20  |      | 20               | nA   |                  |  |
| Digital Control                    | Inputs (IN1, IN2)                                      | •  |   |                          |          |      |      |                  |      |                  |  |
| V <sub>IH</sub>                    | Input logic high                                       |  |   | Full                     |          | 1.5  |      | 5.5              | V    |                  |  |
| V <sub>IL</sub>                    | Input logic low  |  |   | Full                     |          | 0    |      | 0.6              | V    |                  |  |
|                                    | Input leakage  |  |   | 25°C                     |          | -2   | 0.3  | 2                |      |                  |  |
| I <sub>IH</sub> , I <sub>IL</sub>  | current  | $V_1 = 5.5 V \text{ or } 0$  |   | Full                     | 1.95 V   | -20  |      | 20               | μA   |                  |  |
| Dynamic                            |  | 1  |   |                          |          |      |      | 1                |      |                  |  |
| Q <sub>C</sub>                     | Charge injection                                       |  | C <sub>L</sub> = 1 nF,<br>see Figure 19 | 25°C                     | 1.8 V    |      | 2    |                  | рС   |                  |  |
| C <sub>NO(OFF)</sub>               | NO<br>OFF<br>capacitance                               | V <sub>NO</sub> = V <sub>+</sub> or GND,<br>Switch OFF,  | See Figure 14                           | 25°C                     | 1.8 V    |      | 19.5 |                  | pF   |                  |  |
| C <sub>COM(OFF)</sub>              | COM<br>OFF<br>capacitance                              | V <sub>COM</sub> = V <sub>+</sub> or GND,<br>Switch OFF,   | See Figure 14                           | 25°C                     | 1.8 V    |      | 18.5 |                  | pF   |                  |  |
| C <sub>NO(ON)</sub>                | NO<br>ON<br>capacitance                                | $V_{NO} = V_{+}$ or GND,<br>Switch ON,   | See Figure 14                           | 25°C                     | 1.8 V    |      | 36.5 |                  | pF   |                  |  |

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

(2) Not tested in production.

# **Electrical Characteristics: 1.8-V Supply (continued)**

| $V_{+} = 1.65$ V to 1.95 V, $T_{A} = -40^{\circ}$ C to 85°C (unless otherwise | noted) <sup>(1)</sup> |
|---|-----------------------|
|---|-----------------------|

| PA                   | ARAMETER                  | TEST CO   | ONDITIONS                             | TA   | V.      | MIN TYP | MAX  | UNIT |  |
|----------------------|---------------------------|---|---------------------------------------|------|---------|---------|------|------|--|
| C <sub>COM(ON)</sub> | COM<br>ON<br>capacitance  | $V_{COM} = V_+ \text{ or GND},$<br>Switch ON,                       | See Figure 14                         | 25°C | 1.8 V   | 36.5    |      | pF   |  |
| CI                   | Digital input capacitance | $V_1 = V_+ \text{ or GND},$   | See Figure 14                         | 25°C | 1.8 V   | 2       |      | pF   |  |
| BW                   | Bandwidth                 | $R_L = 50 \Omega$ ,<br>Switch ON,                                   | See Figure 16                         | 25°C | 1.8 V   | 150     |      | MHz  |  |
| O <sub>ISO</sub>     | OFF isolation             | $\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$ | Switch OFF,<br>see Figure 17          | 25°C | 1.8 V   | -62     |      | dB   |  |
| THD                  | Total harmonic distortion | $R_L = 600 \Omega,$<br>$C_L = 50 pF,$                               | f = 20 Hz to 20 kHz,<br>see Figure 20 | 25°C | 1.8 V   | 0.055%  |      |      |  |
| Supply               |                           |   |                                       |      |         | L       |      |      |  |
|                      | Positive supply           |   | Switch ON or OFF                      | 25°C | 1.05.1/ | 0.001   | 0.01 |      |  |
| I <sub>+</sub>       | current                   | $V_I = V_+ \text{ or } GND,$  | Switch ON OF OFF                      | Full | 1.95 V  |         | 0.15 | μA   |  |

# 6.9 Switching Characteristics: 5-V Supply

 $V_{+} = 4.5 \text{ V}$  to 5.5 V,  $T_{A} = -40^{\circ}\text{C}$  to 85°C (unless otherwise noted)<sup>(1)</sup>

|                  | PARAMETER   | TEST                    | TEST CONDITIONS         |                | V.  | MIN | TYP | MAX | UNIT |  |  |
|------------------|---|-------------------------|-------------------------|----------------|-----|-----|-----|-----|------|--|--|
| Dynan            | Dynamic   |                         |                         |                |     |     |     |     |      |  |  |
| tau              | Turnon timo   | $V_{COM} = V_+,$        | C <sub>L</sub> = 35 pF, | 25°C           | 5 V | 1   | 4.5 | 7.5 | 20   |  |  |
| t <sub>ON</sub>  | $R_{\rm ON}$ Turnon time $R_{\rm L} = 50 \ \Omega,$ | see Figure 15           | Full                    | 4.5 V to 5.5 V | 1   |     | 9   | ns  |      |  |  |
|                  |   | C <sub>L</sub> = 35 pF, | 25°C                    | 5 V            | 4.5 | 8   | 11  |     |      |  |  |
| t <sub>OFF</sub> |   |                         | Full                    | 4.5 V to 5.5 V | 3.5 |     | 13  | ns  |      |  |  |

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

# 6.10 Switching Characteristics: 3.3-V Supply

| $V_{+} = 3 \text{ V}$ to 3.6 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherw | wise noted) <sup>(1)</sup> |
|--|----------------------------|
|--|----------------------------|

|                  | PARAMETER    | TEST  | TEST CONDITIONS   |                 | V.              | MIN | TYP | MAX  | UNIT |
|------------------|--------------|---|---|-----------------|-----------------|-----|-----|------|------|
| Dynan            | nic          |   |   |                 |                 |     |     |      |      |
|                  |              | V _ V   | C = 25  pF  | 25°C            | 3.3 V           | 1.5 | 5   | 9.5  |      |
| t <sub>ON</sub>  | Turnon time  | $ \begin{array}{ll} V_{\text{COM}} = V_{+}, & C_{\text{L}} = 35 \text{ pF}, \\ R_{\text{L}} = 50 \ \Omega, & \text{see Figure 15} \end{array} $ | Full  | 3 V to<br>3.6 V | 1               |     | 10  | ns   |      |
|                  |              | V V   | $V_{+}$ , $C_{L} = 35 \text{ pF}$ ,<br>0 $\Omega$ , see Figure 15 | 25°C            | 3.3 V           | 4.5 | 8.5 | 11   |      |
| t <sub>OFF</sub> | Turnoff time |   |   | Full            | 3 V to<br>3.6 V | 3   |     | 12.5 | ns   |

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

## 6.11 Switching Characteristics: 2.5-V Supply

 $V_{\star}$  = 2.3 V to 2.7 V,  $T_{A}$  = –40°C to 85°C (unless otherwise noted)  $^{(1)}$ 

| PARAMETER        |              | TES  | TEST CONDITIONS                          |      | V.                | MIN | TYP | MAX  | UNIT |
|------------------|--------------|--|--|------|-------------------|-----|-----|------|------|
| Dynam            | nic          |  |  |      |                   |     |     |      |      |
|                  |              | V - V                                      | 0 – 25 pF                                | 25°C | 2.5 V             | 2   | 6   | 10   |      |
| t <sub>ON</sub>  | Turnon time  | $V_{COM} = V_+,$<br>R <sub>L</sub> = 50 Ω, | C <sub>L</sub> = 35 pF,<br>see Figure 15 | Full | 2.3 V to<br>2.7 V | 1   |     | 12   | ns   |
|                  |              | N N  | 0 25 pF                                  | 25°C | 2.5 V             | 4.5 | 8   | 12.5 |      |
| t <sub>OFF</sub> | Turnoff time | $V_{COM} = V_+,$<br>$R_L = 50 \Omega,$     | C <sub>L</sub> = 35 pF,<br>see Figure 15 | Full | 2.3 V to<br>2.7 V | 3   |     | 15   | ns   |

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.



# 6.12 Switching Characteristics: 1.8-V Supply

 $V_{+}$  = 1.65 V to 1.95 V,  $T_{A}$  = -40°C to 85°C (unless otherwise noted)<sup>(1)</sup>

|                  | PARAMETER TEST CONDITIONS |  |  |      | V.                  | MIN | TYP | MAX  | UNIT |  |  |
|------------------|---------------------------|--|--|------|---------------------|-----|-----|------|------|--|--|
| Dynan            | nic                       |  |  |      |                     |     |     |      |      |  |  |
|                  |                           |  | 0 25 pF                                  | 25°C | 1.8 V               | 3   | 9   | 18   |      |  |  |
| t <sub>ON</sub>  | Turnon time               | $V_{COM} = V_+, \\ R_L = 50 \ \Omega,$ | C <sub>L</sub> = 35 pF,<br>see Figure 15 | Full | 1.65 V to<br>1.95 V | 1   |     | 20   | ns   |  |  |
|                  |                           |  |  | 25°C | 1.8 V               | 5   | 10  | 15.5 |      |  |  |
| t <sub>OFF</sub> | Turnoff time              | $V_{COM} = V_+,$<br>$R_L = 50 \Omega,$ | C <sub>L</sub> = 35 pF,<br>see Figure 15 | Full | 1.65 V to<br>1.95 V | 4   |     | 18.5 | ns   |  |  |

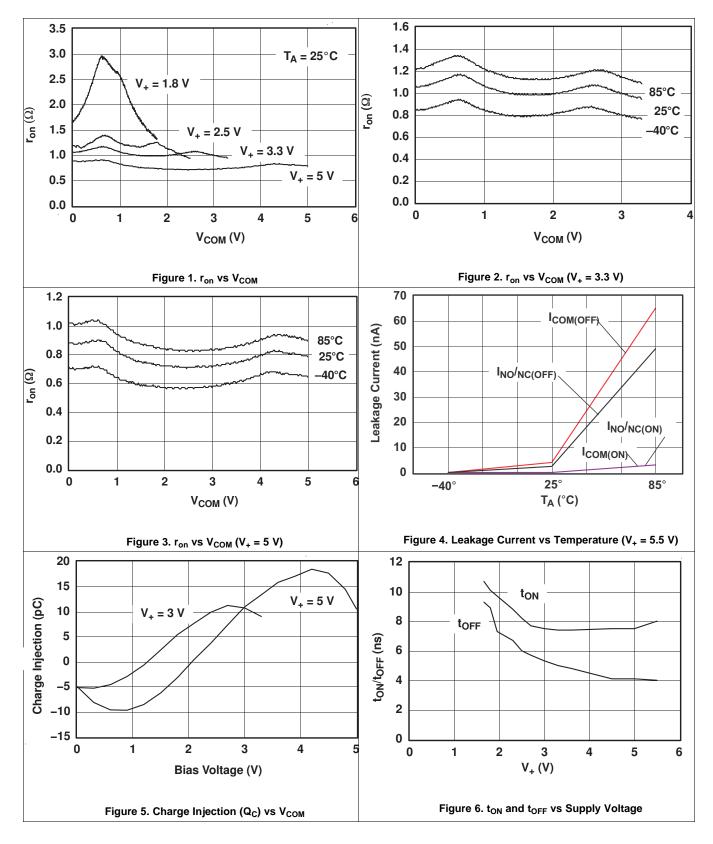
(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

TS5A23166 SCDS196J – MAY 2005 – REVISED SEPTEMBER 2019



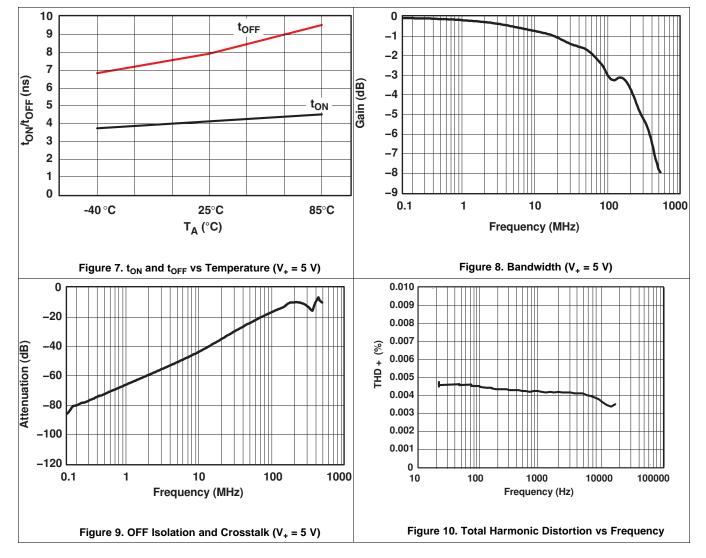
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## 6.13 Typical Characteristics





## **Typical Characteristics (continued)**





## 7 Parameter Measurement Information

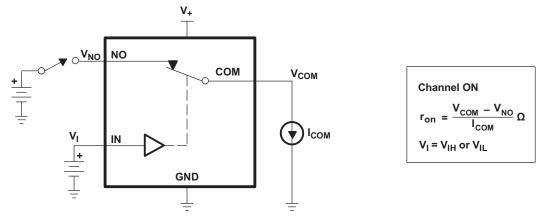


Figure 11. ON-State Resistance (ron)

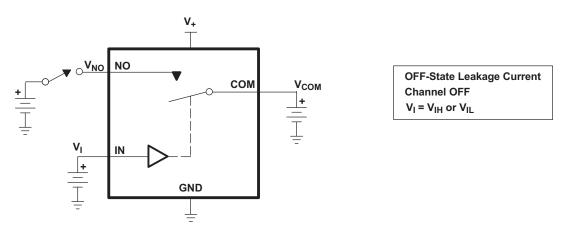


Figure 12. OFF-State Leakage Current (I<sub>COM(OFF)</sub>, I<sub>NC(OFF)</sub>, I<sub>COM(PWROFF)</sub>, I<sub>NC(PWR(FF)</sub>)

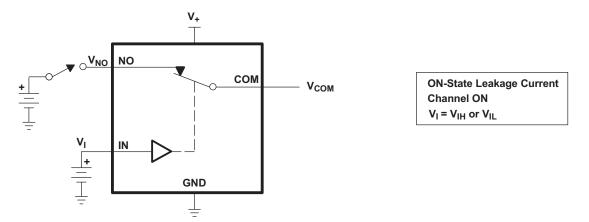
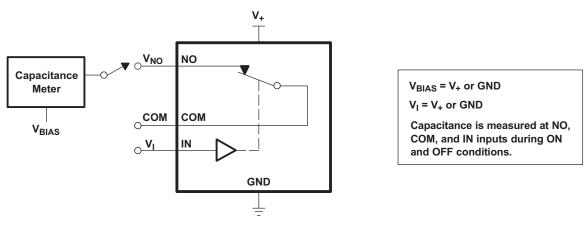


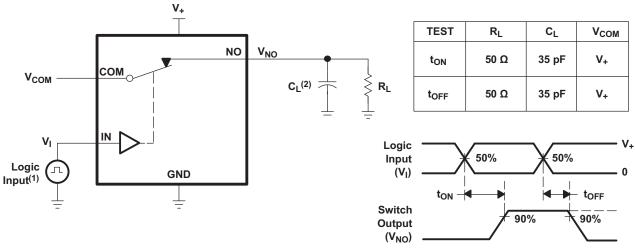
Figure 13. ON-State Leakage Current (I<sub>COM(ON)</sub>, I<sub>NC(ON)</sub>)



**Parameter Measurement Information (continued)** 

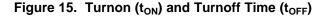


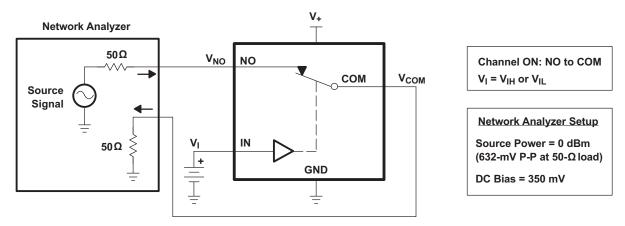




(1) All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>0</sub> = 50  $\Omega$ , t<sub>r</sub> < 5 ns, t<sub>f</sub> < 5 ns.

(2) C<sub>L</sub> includes probe and jig capacitance.







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## **Parameter Measurement Information (continued)**

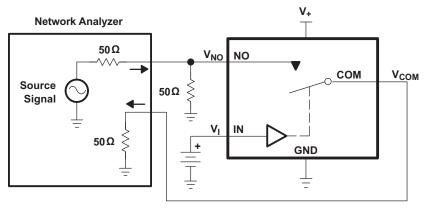
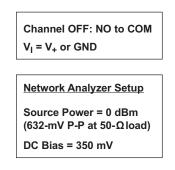


Figure 17. OFF Isolation (O<sub>ISO</sub>)



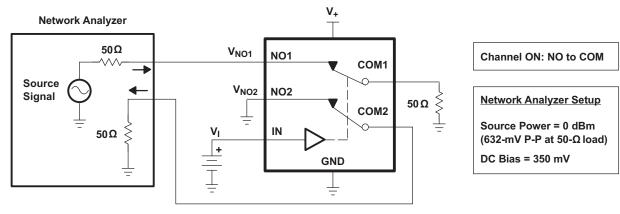
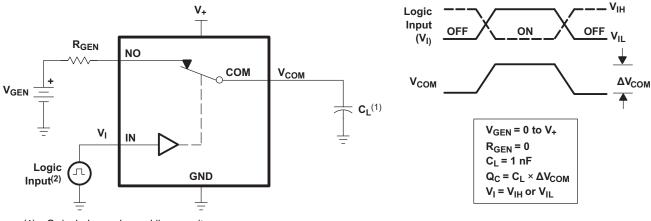


Figure 18. Crosstalk (X<sub>TALK</sub>)

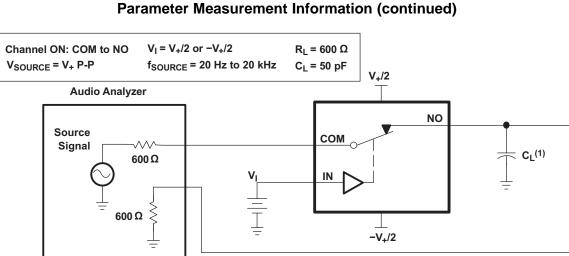


(1)  $C_L$  includes probe and jig capacitance.

(2) All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz,  $Z_0$  = 50  $\Omega$ ,  $t_r$  < 5 ns,  $t_f$  < 5 ns.

### Figure 19. Charge Injection (Q<sub>c</sub>)





(1)  $C_L$  includes probe and jig capacitance.

Figure 20. Total Harmonic Distortion (THD)

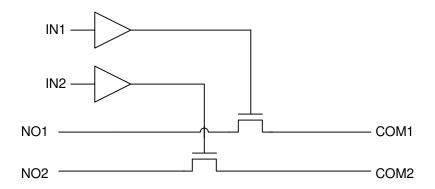


## 8 Detailed Description

### 8.1 Overview

The TS5A23166 is a dual single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance. The device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications. Table 2 shows the descriptions of each parameter specified in the datasheet.

## 8.2 Functional Block Diagram



### 8.3 Feature Description

Tolerant control inputs allow 5-V logic levels to be present on the IN pin at any value of V<sub>CC</sub>. Low ON-resistance allows minimal signal distortion through device.

### 8.4 Device Functional Modes

Table 1 shows the functional modes for TS5A23166.

| IN | NO TO COM,<br>COM TO NO |
|----|-------------------------|
| L  | OFF                     |
| Н  | ON                      |

#### Table 1. Function Table



## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The TS5A23166 dual SPST analog switch is a basic component that could be used in any electrical system design. One example application is a gain selector, which is described in the *Typical Application* section.

### 9.2 Typical Application

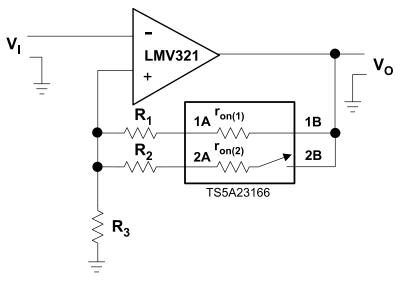


Figure 21. Gain-Control Circuit for OP Amplifier

### 9.2.1 Design Requirements

By selecting values of R1 and R2, such that  $Rx >> r_{on(x)}$ ,  $r_{on}$  of TS5A23166 can be ignored. The gain of op amp can be calculated as follow:

| Vo / VI = 1+ R   / R3                    | (1) |
|--|-----|
| $R   = (R1+r_{on(1)})    (R2+r_{on(2)})$ | (2) |

#### 9.2.2 Detailed Design Procedure

Place a switch in series with the input of the op amp. Because the op amp input impedance is very large, a switch on  $r_{on(1)}$  is irrelevant.

# **Typical Application (continued)**

9.2.3 Application Curve

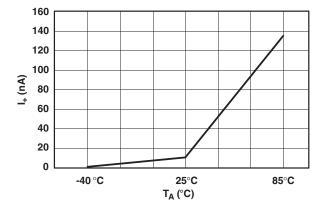


Figure 22. Power-Supply Current vs Temperature ( $V_{+} = 5 V$ )

# **10 Power Supply Recommendations**

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions*.

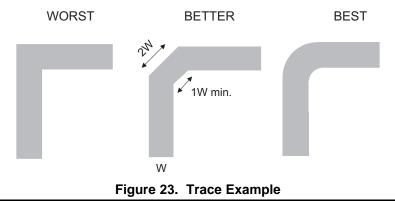
Each V<sub>CC</sub> terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, a 0.1- $\mu$ F bypass capacitor is recommended. If there are multiple pins labeled V<sub>CC</sub>, then a 0.01- $\mu$ F or 0.022- $\mu$ F capacitor is recommended for each V<sub>CC</sub> because the VCC pins will be tied together internally. For devices with dual supply pins operating at different voltages, for example V<sub>CC</sub> and V<sub>DD</sub>, a 0.1- $\mu$ F bypass capacitor is recommended for each supply pin. It is acceptable to parallel multiple bypass capacitors to reject different frequencies of noise. 0.1- $\mu$ F and 1- $\mu$ F capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

# 11 Layout

## 11.1 Layout Guidelines

Reflections and matching are closely related to loop antenna theory, but different enough to warrant their own discussion. When a PCB trace turns a corner at a 90° angle, a reflection can occur. This is primarily due to the change of width of the trace. At the apex of the turn, the trace width is increased to 1.414 times its width. This upsets the transmission line characteristics, especially the distributed capacitance and self–inductance of the trace — resulting in the reflection. It is a given that not all PCB traces can be straight, and so they will have to turn corners. Figure 23 shows progressively better techniques of rounding corners. Only the last example maintains constant trace width and minimizes reflections.

## 11.2 Layout Example





# **12** Device and Documentation Support

# 12.1 Device Support

# 12.1.1 Device Nomenclature

| INNORFP   input and output conditions     INO(PWROFF)   Leakage current measured at the NO port during the power-down condition, V <sub>+</sub> = 0     IcoM(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under wors case input and output conditions     IcoM(OFF)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open     IcoM(ON)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output (COM) open     VIH   Minimum input voltage for logic high for the control input (IN)     VIL   Maximum input voltage for logic low for the control input (IN)     VIL   Maximum input voltage for logic low for the control input (IN)     VIL   Value at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Value at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at analog output (COM or NO) signal when the switch is turning ON.     tops   Turnon time for the switch. This parameter is measured un   | SYMBOL                            | DESCRIPTION  |
|---|-----------------------------------|--|
| VNO   Voltage at NO     r <sub>en</sub> Resistance between COM and NO ports when the channel is ON     r <sub>peak</sub> Peak on-state resistance over a specified voltage range     r <sub>on(tett)</sub> Difference between the maximum and minimum value of r <sub>on</sub> in a channel over the specified range of conditions     INO(COFF)   Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF-state under worst-conditions     IcoM(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst-case input and output conditions     IcoM(OFF)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open     IcoM(ON)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open     VI <sub>H</sub> Minimum input voltage for logic low for the control input (IN)     IcoM(ON)   Leakage current measured at the control input (IN)     VI <sub>H</sub> Maximum input voltage for logic low for the control input (IN)     VI <sub>H</sub> Leakage current measured at the control input (IN)     Input fire for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ONF.     Cprec   Charepai  | V <sub>COM</sub>                  | Voltage at COM   |
| Peak on-state resistance over a specified voltage range     form(mai)   Difference between the maximum and minimum value of r <sub>on</sub> in a channel over the specified range of conditions     INO(OFF)   Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF-state under worst-clinput and output conditions     INO(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst-cases input and output conditions     Icom(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst-cases input and output conditions     Icom(ON)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open     Icom(ON)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output (NO) open     Icom(ON)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output (NO) open     Vist   Minimum input voltage for logic low for the control input (IN)     Vist   Minimum input voltage for logic low for the control input (IN)     Vist   Vist and the control input (IN)     Vist   Turnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the swi  |                                   | Voltage at NO  |
| rpeak   Peak on-state resistance over a specified voltage range     frontliat)   Difference between the maximum and minimum value of r <sub>on</sub> in a channel over the specified range of conditions     INO(OFF)   Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF-state under worst-<br>input and output conditions     INO(PWROFF)   Leakage current measured at the NO port during the power-down condition, V <sub>+</sub> = 0     IcoM(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst<br>cases input and output conditions     IcOM(ONF)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output<br>(COM) open     IcOM(ON)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output<br>(COM) open     VI <sub>H</sub> Minimum input voltage for logic high for the control input (IN)     VI <sub>L</sub> Maximum input voltage for logic low for the control input (IN)     VI <sub>H</sub> Voltage at the control input (IN)     VI <sub>H</sub> Leakage current measured at the Control input (IN)     VI <sub>H</sub> Leakage current measured at the control input (IN)     VI <sub>H</sub> Leakage current measured at the control input (IN)     VI <sub>H</sub> Leakage current measured at the control input (IN)     VI <sub>H</sub>   | r <sub>on</sub>                   | Resistance between COM and NO ports when the channel is ON   |
| INO(OFF)   Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF-state under worst-cripput and output conditions     INO(OFF)   Leakage current measured at the NO port, with the corresponding channel (COM to NO) in the OFF-state under worst-case input and output conditions     Icom(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst-case input and output conditions     Icom(PWROFF)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open     Ivo(ON)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output (NO) open     V <sub>IH</sub> Minimum input voltage for logic high for the control input (IN)     V <sub>IL</sub> Maximum input voltage for logic low for the control input (IN)     V <sub>I</sub> Voltage at the control input (IN)     V <sub>II</sub> Maximum input voltage for logic low for the control input (IN)     V <sub>II</sub> Valage at the control input (IN)     V <sub>II</sub> Valage at the control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF.     Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)     Qc   Charge injection, Qc = C x AV <sub>COM</sub> , C <sub>L</sub> is the load capacitance, and AV <sub>COM</sub> is the change in analog output voltage.  |                                   | Peak on-state resistance over a specified voltage range  |
| INNOFF   input and output conditions     INO(PWROFF)   Leakage current measured at the NO port during the power-down condition, V <sub>+</sub> = 0     IcoM(OFF)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under wors case input and output conditions     IcOM(ONF)   Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open     IcoM(ON)   Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output (COM) open     VIH   Minimum input voltage for logic high for the control input (IN)     VIL   Maximum input voltage for logic low for the control input (IN)     VIL   Maximum input voltage for logic low for the control input (IN)     VIL   Voltage at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Maximum input voltage for logic low for the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at the control input (IN)     VIL   Leakage current measured at the control input (IN)  | r <sub>on(flat)</sub>             | Difference between the maximum and minimum value of ron in a channel over the specified range of conditions  |
| Icom(OFF)Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under wors<br>case input and output conditionsIcom(PWROFF)Leakage current measured at the COM port during the power-down condition, $V_{+} = 0$ Iko(ON)Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON-state and the output<br>(COM) openIcom(ON)Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output<br>(NO) openVIHMinimum input voltage for logic high for the control input (IN)VILMaximum input voltage for logic low for the control input (IN)VILVoltage at the control input (IN)VILVoltage at the control input (IN)Inno time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.CFFTurnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.QcCharge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>charge injection, $Q_c = C_L \propto \Delta V_{COM}$ . $C_L$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage.CNO(OFF)Capacitance at the NO port when the corresponding channel (NO to COM) is OFFCom(OFF)Capacitance at the COM port when the  | I <sub>NO(OFF)</sub>              | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF-state under worst-case input and output conditions  |
| ICOM(OFF)case input and output conditionsIcom(PWROFF)Leakage current measured at the COM port during the power-down condition, $V_* = 0$ INO(ON)Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON-state and the output<br>(COM) openIcom(ON)Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output<br>(NO) openV <sub>IH</sub> Minimum input voltage for logic high for the control input (IN)V <sub>IL</sub> Maximum input voltage for logic low for the control input (IN)V <sub>IL</sub> Voltage at the control input (IN)V <sub>IL</sub> Value at the control input (IN)I <sub>H</sub> , I <sub>IL</sub> Leakage current measured at the control input (IN)tonTurnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.torFFTurnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF.Q <sub>C</sub> Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>charge induced, due to switching of the control input<br>charge induced, due to switching of the control input<br>charge induced due to switchi  | I <sub>NO(PWROFF)</sub>           | Leakage current measured at the NO port during the power-down condition, $V_{+} = 0$   |
| Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON-state and the output<br>(COM) openLeakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output<br>(NO) openV <sub>IH</sub> Minimum input voltage for logic high for the control input (IN)V <sub>IL</sub> Maximum input voltage for logic low for the control input (IN)VIVoltage at the control input (IN)VILeakage current measured at the control input (IN)VIVoltage at the control input (IN)VILeakage current measured at the control input (IN)VITurnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.toFFTurnoft time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF.Q <sub>C</sub> Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in couldous (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, Q <sub>C</sub> = C <sub>L</sub> × $\Delta V_{COM}$ , C <sub>L</sub> is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage.CNO(OFF)Capacitance at the COM port when the corresponding channel (NO to COM) is OFFCOM(ON)Capacitance at the COM port when the corresponding channel (COM to NO) is ONCom(ON)Capacitance at the COM port when the corresponding channel (NO to COM) is ON <tr< td=""><td>I<sub>COM(OFF)</sub></td><td>Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst-<br/>case input and output conditions</td></tr<> | I <sub>COM(OFF)</sub>             | Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF-state under worst-<br>case input and output conditions                                   |
| NO(ON)(COM) open $l_{COM(ON)}$ Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the outp<br>(NO) open $V_{IH}$ Minimum input voltage for logic high for the control input (IN) $V_{IL}$ Maximum input voltage for logic low for the control input (IN) $V_{IL}$ Maximum input voltage for logic low for the control input (IN) $V_{IL}$ Maximum input voltage for logic low for the control input (IN) $V_{IL}$ Maximum input voltage for logic low for the control input (IN) $V_{IL}$ Leakage current measured at the control input (IN) $I_{IH}$ Leakage current measured at the control input (IN) $t_{IN}$ Turnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $0_{CF}$ Turnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $0_{CC}$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>  | I <sub>COM(PWROFF)</sub>          | Leakage current measured at the COM port during the power-down condition, $V_{+} = 0$  |
| ICOM(ON)(NO) open $V_{\text{IH}}$ Minimum input voltage for logic high for the control input (IN) $V_{\text{IL}}$ Maximum input voltage for logic low for the control input (IN) $V_{\text{IL}}$ Maximum input voltage for logic low for the control input (IN) $V_{\text{IL}}$ Voltage at the control input (IN) $V_{\text{IL}}$ Voltage at the control input (IN) $V_{\text{IL}}$ Leakage current measured at the control input (IN) $V_{\text{IL}}$ Leakage current measured at the control input (IN) $t_{\text{ON}}$ Turnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. $t_{\text{OFF}}$ Turnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_{\text{C}}$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in colomb (C) and measured by the total charge induced due to switching of the control input<br>(CArge injection, $Q_{\text{C}} = C_{\text{L}} \propto \Delta_{\text{COM}}$ , $C_{\text{L}}$ is the load capacitance, and $\Delta_{\text{COM}}$ is the change in analog output voltage. $C_{\text{NO(OFF}}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{\text{COM(ON)}}$ Capacitance at the NO port when the corresponding channel (COM to NO) is ON $C_{\text{COM(ON)}}$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_{\text{COM(ON)}}$ Capacitance  | I <sub>NO(ON)</sub>               | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON-state and the output (COM) open  |
| $V_{IL}$ Maximum input voltage for logic low for the control input (IN) $V_1$ Voltage at the control input (IN) $I_{IH}$ , $I_{IL}$ Leakage current measured at the control input (IN) $t_{ON}$ Turnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. $t_{ON}$ Turnof time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_{CF}$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, $Q_C = C_L \times \Delta V_{COM}$ . $C_L$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage. $C_{NO(OFF)}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{COM(OFF)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON<br>Comol(ON) $C_1$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_1$ Capacitance of control input (IN) $O_1$ OFF- isolation of the switch. This is the frequency in which the GOT to NO) is ON $C_1$ Capacitance of control input (IN) $O_1$ OFF- isolation of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.THDBandwidth of the switch. This is the frequency in which the gain of   | I <sub>COM(ON)</sub>              | Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON-state and the output (NO) open  |
| V1Voltage at the control input (IN)I1H, I1LLeakage current measured at the control input (IN)toNTurnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.toFFTurnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF.QCCharge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, QC = CL × $\Delta V_{COM}$ , CL is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage.CNO(OFF)Capacitance at the NO port when the corresponding channel (NO to COM) is OFFCCOM(OFF)Capacitance at the COM port when the corresponding channel (COM to NO) is OFFCNO(ON)Capacitance at the COM port when the corresponding channel (NO to COM) is ONCCOM(ON)Capacitance at the COM port when the corresponding channel (COM to NO) is ONC1Capacitance of control input (IN)O1SOOFF isolation of the switch. This is a measurement of OFF-state switch impedance. This is measured in dB in a specific<br>frequency, with the corresponding channel (NO to COM) in the OFF state.BWBandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.THDTotal harmonic distortion describes the signal distortion caused by the  | V <sub>IH</sub>                   | Minimum input voltage for logic high for the control input (IN)  |
| InterviewInterview $I_{IH}$ , $I_{IL}$ Leakage current measured at the control input (IN) $I_{IH}$ , $I_{IL}$ Leakage current measured at the control input (IN) $I_{ON}$ Turnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. $I_{OFF}$ Turnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_C$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, $Q_C = C_L \times \Delta V_{COM}$ , $C_L$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage. $C_{NO(OFF)}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{COM(OFF)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_{COM(ON)}$ Capacitance of control input (IN) $O_{ISO}$ OFF isolation of the switch. This is a measurement of OFF-state switch impedance. This is measured in dB in a specific<br>frequency, with the corresponding channel (NO to COM   | V <sub>IL</sub>                   | Maximum input voltage for logic low for the control input (IN)   |
| InitialTurnon time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. $t_{OFF}$ Turnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_{C}$ Turnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_{C}$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, $Q_{C} = C_{L} \times \Delta V_{COM}$ , $C_{L}$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage. $C_{NO(OFF)}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_1$ Capacitance of control input (IN) $O_{ISO}$ OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific<br>frequency, with the corresponding channel (NO to COM) in the OFF state.BWBandwidth of the switch. This is the frequency in which the gain of an ON channel is $-3$ dB below the DC gain.THDTotal harmonic   | VI                                | Voltage at the control input (IN)  |
| LONdelay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. $t_{OFF}$ Turnoff time for the switch. This parameter is measured under the specified range of conditions and by the propagation<br>delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_C$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, $Q_C = C_L \times \Delta V_{COM}$ , $C_L$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage. $C_{NO(OFF)}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{COM(OFF)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance of control input (IN) $O_{ISO}$ OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific<br>frequency, with the corresponding channel (NO to COM) in the OFF state.BWBandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.THDTotal harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root<br>mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental<br>harmonic.  | I <sub>IH</sub> , I <sub>IL</sub> | Leakage current measured at the control input (IN)   |
| IOFFdelay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. $Q_C$ Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM)<br>output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, $Q_C = C_L \times \Delta V_{COM}$ , $C_L$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage. $C_{NO(OFF)}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{COM(OFF)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (NO to NO) is ON $C_{COM(ON)}$ Capacitance of control input (IN) $O_{ISO}$ OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific<br>frequency, with the corresponding channel (NO to COM) in the OFF state.BWBandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.THDTotal harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root<br>mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental<br>harmonic.  | t <sub>ON</sub>                   |  |
| $Q_C$ output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input<br>Charge injection, $Q_C = C_L \times \Delta V_{COM}$ , $C_L$ is the load capacitance, and $\Delta V_{COM}$ is the change in analog output voltage. $C_{NO(OFF)}$ Capacitance at the NO port when the corresponding channel (NO to COM) is OFF $C_{COM(OFF)}$ Capacitance at the COM port when the corresponding channel (COM to NO) is OFF $C_{NO(ON)}$ Capacitance at the COM port when the corresponding channel (NO to COM) is ON $C_{COM(ON)}$ Capacitance at the COM port when the corresponding channel (COM to NO) is ON $C_{COM(ON)}$ Capacitance of control input (IN) $O_{ISO}$ OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific<br>frequency, with the corresponding channel (NO to COM) in the OFF state.BWBandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.THDTotal harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root<br>mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental<br>harmonic.  | t <sub>OFF</sub>                  |  |
| Com(OFF) Capacitance at the COM port when the corresponding channel (COM to NO) is OFF   C <sub>NO(ON)</sub> Capacitance at the NO port when the corresponding channel (NO to COM) is ON   C <sub>COM(ON)</sub> Capacitance at the COM port when the corresponding channel (COM to NO) is ON   C <sub>COM(ON)</sub> Capacitance at the COM port when the corresponding channel (COM to NO) is ON   C <sub>COM(ON)</sub> Capacitance of control input (IN)   O <sub>ISO</sub> OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.   BW Bandwidth of the switch. This is the frequency in which the gain of an ON channel is –3 dB below the DC gain.   THD Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.   | Q <sub>C</sub>                    | output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input.  |
| C <sub>NO(ON)</sub> Capacitance at the NO port when the corresponding channel (NO to COM) is ON   C <sub>COM(ON)</sub> Capacitance at the COM port when the corresponding channel (COM to NO) is ON   C <sub>1</sub> Capacitance of control input (IN)   O <sub>ISO</sub> OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.   BW Bandwidth of the switch. This is the frequency in which the gain of an ON channel is –3 dB below the DC gain.   THD Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.  | C <sub>NO(OFF)</sub>              | Capacitance at the NO port when the corresponding channel (NO to COM) is OFF   |
| C <sub>COM(ON)</sub> Capacitance at the COM port when the corresponding channel (COM to NO) is ON   C <sub>1</sub> Capacitance of control input (IN)   O <sub>ISO</sub> OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.   BW Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.   THD Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.  | C <sub>COM(OFF)</sub>             | Capacitance at the COM port when the corresponding channel (COM to NO) is OFF  |
| C1 Capacitance of control input (IN)   OISO OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.   BW Bandwidth of the switch. This is the frequency in which the gain of an ON channel is –3 dB below the DC gain.   THD Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.  | C <sub>NO(ON)</sub>               | Capacitance at the NO port when the corresponding channel (NO to COM) is ON  |
| O <sub>ISO</sub> OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.     BW   Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.     THD   Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.   | C <sub>COM(ON)</sub>              | Capacitance at the COM port when the corresponding channel (COM to NO) is ON   |
| OISO frequency, with the corresponding channel (NO to COM) in the OFF state.   BW Bandwidth of the switch. This is the frequency in which the gain of an ON channel is –3 dB below the DC gain.   THD Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.  | Cl                                | Capacitance of control input (IN)  |
| THD Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.  | O <sub>ISO</sub>                  | OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state. |
| THD mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.  | BW                                | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.  |
| Static power supply current with the control (IN) pip at V ar CND   | THD                               |  |
|   | l+                                | Static power-supply current with the control (IN) pin at V <sub>+</sub> or GND   |



## 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 12.3 Community Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 12.4 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

### 12.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## 12.6 Glossary

### SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



# PACKAGING INFORMATION

| Orderable Device | Status | Package Type |         | Pins | Package | Eco Plan     | Lead finish/  | MSL Peak Temp      | Op Temp (°C) | Device Marking         | Samples |
|------------------|--------|--------------|---------|------|---------|--------------|---------------|--------------------|--------------|------------------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)          | Ball material | (3)                |              | (4/5)                  |         |
|                  |        |              |         |      |         |              | (6)           |                    |              |                        |         |
| TS5A23166DCUR    | ACTIVE | VSSOP        | DCU     | 8    | 3000    | RoHS & Green | NIPDAU   SN   | Level-1-260C-UNLIM | -40 to 85    | (AM, JAMQ, JAMR)<br>JZ | Samples |
| TS5A23166DCURG4  | ACTIVE | VSSOP        | DCU     | 8    | 3000    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | JAMR                   | Samples |
| TS5A23166YZPR    | ACTIVE | DSBGA        | YZP     | 8    | 3000    | RoHS & Green | SNAGCU        | Level-1-260C-UNLIM | -40 to 85    | JMN                    | Samples |
| TS5A23166YZTR    | ACTIVE | DSBGA        | YZT     | 8    | 3000    | RoHS & Green | SNAGCU        | Level-1-260C-UNLIM | -40 to 85    | JMN                    | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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STRUMENTS

# TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |   |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| TS5A23166DCUR               | VSSOP           | DCU                | 8 | 3000 | 178.0                    | 9.5                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| TS5A23166DCUR               | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| TS5A23166DCUR               | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 9.0                      | 2.25       | 3.4        | 1.0        | 4.0        | 8.0       | Q3               |
| TS5A23166DCURG4             | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| TS5A23166YZPR               | DSBGA           | YZP                | 8 | 3000 | 178.0                    | 9.2                      | 1.02       | 2.02       | 0.63       | 4.0        | 8.0       | Q1               |
| TS5A23166YZTR               | DSBGA           | YZT                | 8 | 3000 | 178.0                    | 9.2                      | 1.02       | 2.02       | 0.75       | 4.0        | 8.0       | Q1               |



# PACKAGE MATERIALS INFORMATION

30-May-2024



| All ultrensions are norminal |              |                 |      |      |             |            |             |
|------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| TS5A23166DCUR                | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| TS5A23166DCUR                | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| TS5A23166DCUR                | VSSOP        | DCU             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| TS5A23166DCURG4              | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| TS5A23166YZPR                | DSBGA        | YZP             | 8    | 3000 | 220.0       | 220.0      | 35.0        |
| TS5A23166YZTR                | DSBGA        | YZT             | 8    | 3000 | 220.0       | 220.0      | 35.0        |

# YZP0008



# **PACKAGE OUTLINE**

# DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.



# YZP0008

# **EXAMPLE BOARD LAYOUT**

# DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



# YZP0008

# **EXAMPLE STENCIL DESIGN**

# DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



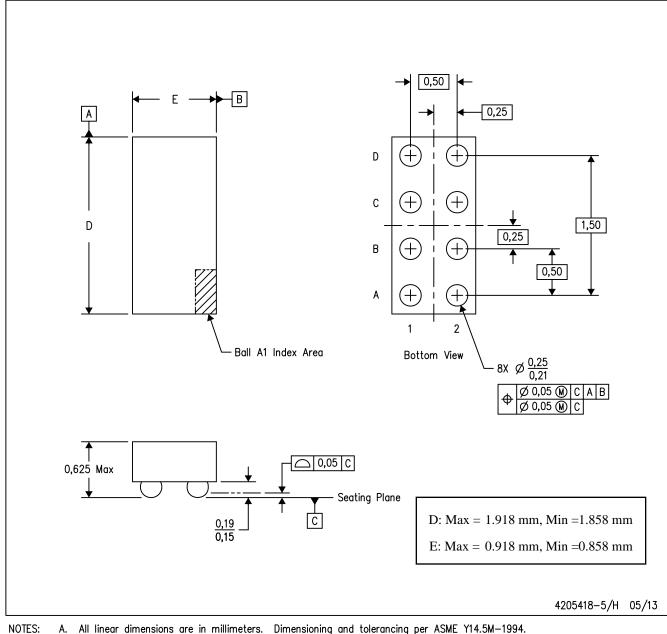
NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



YZT (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



B. This drawing is subject to change without notice.

C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.



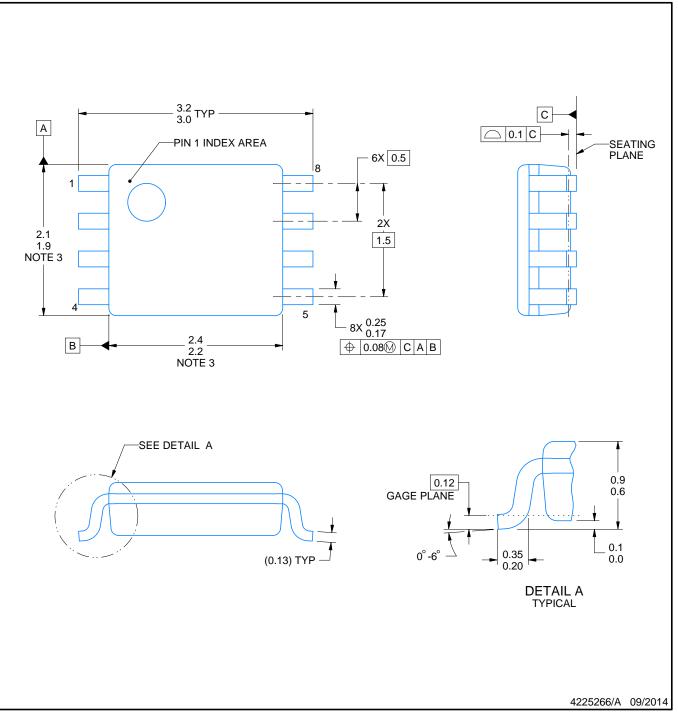
# **DCU0008A**



# **PACKAGE OUTLINE**

# VSSOP - 0.9 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-187 variation CA.



# DCU0008A

# **EXAMPLE BOARD LAYOUT**

# VSSOP - 0.9 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DCU0008A

# **EXAMPLE STENCIL DESIGN**

# VSSOP - 0.9 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

8. Board assembly site may have different recommendations for stencil design.



<sup>7.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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